



Features

- •ULTRA BRIGHTNESS.
- •OUTSTANDING MATERIAL EFFICIENCY.
- •RELIABLE AND RUGGED.
- •IC COMPATIBLE/LOW CURRENT CAPABILITY.

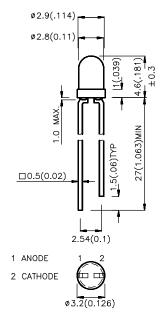
L-934SYCK SUPER BRIGHT YELLOW

Package Dimensions

Description

The Super Bright Yellow source color devices are made with

DH InGaAIP on GaAs substrate Light Emitting Diode.



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.
- 3. Lead spacing is measured where the lead emerge package.
- 4. Specifications are subjected to change without notice.

Selection Guide

Part No.	Dice	Lens Type	lv (mcd) @ 20 mA		Viewing Angle
			Min.	Тур.	201/2
L-934SYCK	SUPER BRIGHT YELLOW (InGaAIP)	WATER CLEAR	200	400	50°

Note:

1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.



Electrical / Optical Characteristics at T_A=25°C

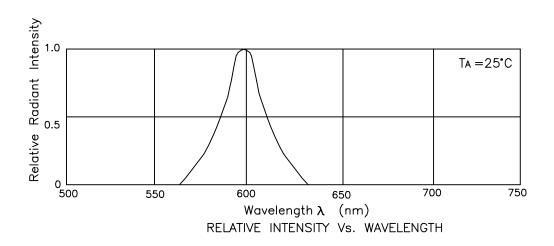
Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Super Bright Yellow	590		nm	IF=20mA
Δλ1/2	Spectral Line Halfwidth	Super Bright Yellow	20		nm	IF=20mA
С	Capacitance	Super Bright Yellow	33		pF	VF=0V;f=1MHz
V _F	Forward Voltage	Super Bright Yellow	2.0	2.4	V	IF=20mA
I _R	Reverse Current	All		10	uA	VR = 5V

Absolute Maximum Ratings at T_A=25°C

Parameter	Super Bright Yellow		
Power dissipation	125	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Operating/Storage Temperature	-40°C To +85°C		
Lead Soldering Temperature [2]	260°C For 5 Seconds		

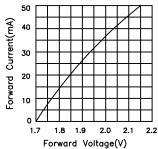
Notes

- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
- 2. 4mm below package base.





Super Bright Yellow L-934SYCK



FORWARD CURRENT Vs. FORWARD VOLTAGE

